

Electronic Patent Application Fee Transmittal

Application Number:	10807527			
Filing Date:	24-Mar-2004			
Title of Invention:	Land grid array packaged device and method of forming same			
First Named Inventor:	Hei Ming Shiu			
Filer:	Joanna Gariazzo Chiu/Pat Thomas			
Attorney Docket Number:	SC13154HP			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				500